

Description

The DMP3036SFV-13 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

 $V_{DS} = -30V$ $I_{D} = -25A$

 $R_{DS(ON)}$ < 20m Ω @ V_{GS} =-10V

Application

Battery protection

Load switch

Uninterruptible power supply

Package Marking and Ordering Information

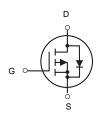
Product ID	Pack	Brand	Qty(PCS)
DMP3036SFV-13	DFN3X3-8L(PowerDI3333-8)	HXY MOSFET	3000

Absolute Maximum Ratings (T_c=25[°]Cunless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	-30	V
VGS	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	-25	А
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	-20	А
IDM	Pulsed Drain Current ²	-65	А
EAS	Single Pulse Avalanche Energy ³	72.2	mJ
P _D @T _C =25°C	Total Power Dissipation ⁴	29	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R₀JC	Thermal Resistance Junction-Case ¹	2.8	°C/W



DFN3X3-8L (PowerDI3333-8)



P-Channel MOSFET

P-Channel Enhancement Mode MOSFET

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-30			V
$\triangleBV_{DSS}/\triangleT_J$	BV _{DSS} Temperature Coefficient	Reference to 25°C, I D=-1mA		-0.022		V/°C
R _{DS(ON)}		V _{GS} =-10V , I _D =-15A		16	20	mΩ
	Static Drain-Source On-Resistance ²	V _{GS} =-4.5V , I _D =-10A		22	32	
V _{GS(th)}	Gate Threshold Voltage		-1.0		-2.5	V
$\Delta V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=-250uA$		4.6		mV/°C
	Danier Common London and Common to	V _{DS} =-24V , V _{GS} =0V , T _J =25°C			-1	uA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-24V , V _{GS} =0V , T _J =55°C			-5	
Igss	Gate-Source Leakage Current	V _{GS} =±25V , V _{DS} =0V			±100	nA
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		13		Ω
Qg	Total Gate Charge (-4.5V)			52		
Q _{gs}	Gate-Source Charge	V _{DS} =-15V , V _{GS} =-4.5V , I _D =-15A		9.8		nC
Q _{gd}	Gate-Drain Charge			8.3		
T _{d(on)}	Turn-On Delay Time			13		
Tr	Rise Time	V_{DD} =-15V , V_{GS} =-10V , R_{G} =3.3 Ω ,		15		
T _{d(off)}	Turn-Off Delay Time	I _D =-15A		198		ns
Tf	Fall Time			98		
Ciss	Input Capacitance			1150		
Coss	Output Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		150		pF
Crss	Reverse Transfer Capacitance			134		
ls	Continuous Source Current ^{1,5}	Ve=Ve=0V Force Current			-32	Α
Ism	Pulsed Source Current ^{2,5}	V _G =V _D =0V , Force Current			-65	Α
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =-1A , T _J =25°C			-1.2	V

Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper. 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =-25V, V_{GS} =-10V, L=0.1mH, I_{AS} =-38A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.



Typical Characteristics

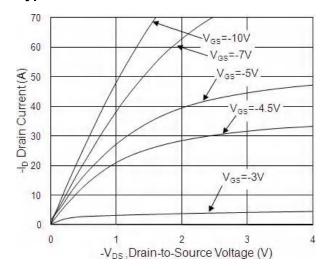


Fig.1 Typical Output Characteristics

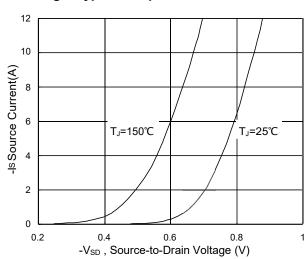


Fig.3 Forward Characteristics of Reverse

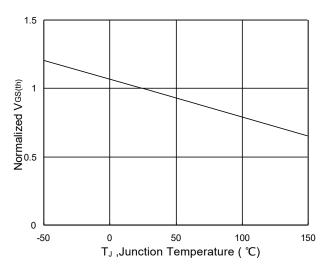


Fig.5 Normalized $V_{\text{GS(th)}}$ vs. T_{J}

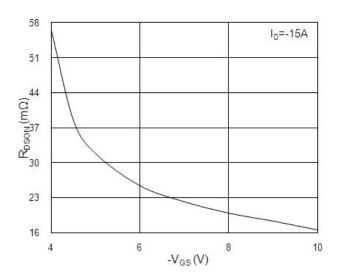


Fig.2 On-Resistance v.s Gate-Source

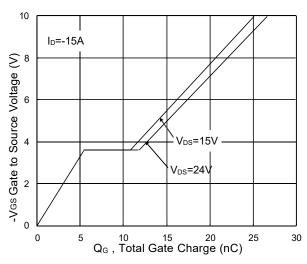


Fig.4 Gate-Charge Characteristics

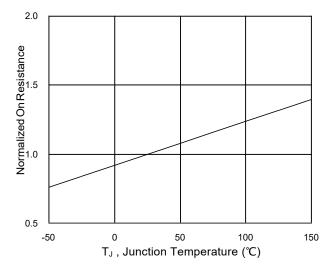
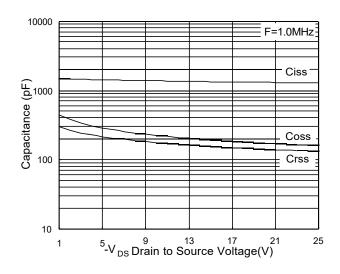


Fig.6 Normalized RDSON vs. TJ



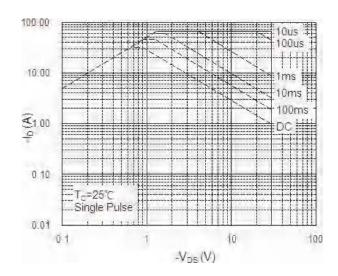


Fig.7 Capacitance

Fig.8 Safe Operating Area

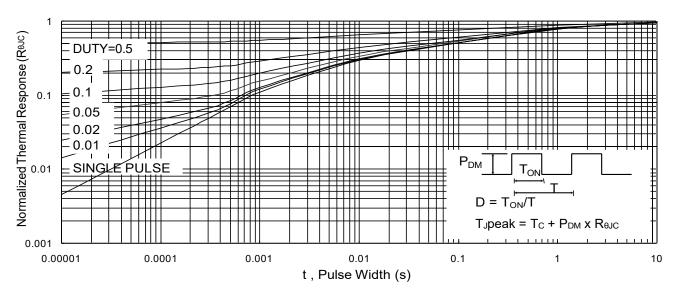


Fig.9 Normalized Maximum Transient Thermal Impedance

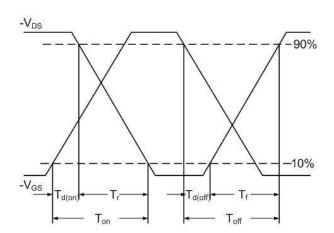


Fig.10 Switching Time Waveform

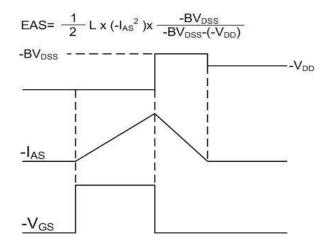
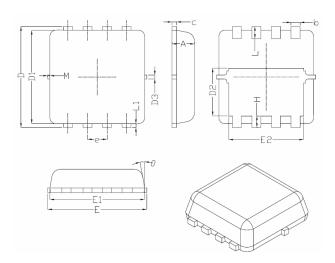


Fig.11 Unclamped Inductive Switching Waveform



DFN3X3-8L(PowerDI3333-8) Package Information



Complete I	Dimensions In Millimeters			
Symbol	Min.	Nom.	Max.	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
С	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.10	3.20	
D2	1.48	1.58	1.68	
D3	-	0.13	-	
E	3.20	3.30	3.40	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
е	0.65BSC			
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1	-	0.13	-	
M	*	*	0.15	
θ		10 [°]	12 [°]	



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